

VO₂ Films Prepared by Atomic Layer Deposition and RF Magnetron Sputtering

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Among the vanadium oxides, VO₂ has been made considerable research efforts due to its remarkable metal-insulator transition (MIT) or semiconductor-metal transition (SMT) behavior, a dramatic reversible change in its electrical and optical properties occurring across the phase transition at 321K [1, 2]. Electrically, the resistivity of VO₂ can be changed as large as four or five orders of magnitude; Optically, VO₂ thin films are also infrared transmission with the insulating phase and highly reflective in the metallic state. All these properties result from a transformation in crystallographic structure, which transitions from a low temperature monoclinic form to a high temperature tetragonal phase. In addition VO₂ is also a thermochromic material which can be employed in smart windows. Therefore, VO₂ has potential to be used in nonvolatile resistive memories, switches in microelectronics and optical sensors.

VO₂ films have been prepared using many techniques, including Reactive Bias Target Ion Beam Deposition (RBTIBD), magnetron sputtering, metal organic chemical deposition (MO-CVD), pulsed laser deposition (PLD) and sol-gel spin coating. Recently, atomic layer deposition (ALD) has been extensively investigated for the deposition of thin films of semiconductors, metals, alloys and oxides. This technique exhibits greatest potential for deposition of accurately controlled thickness and exceptional conformality of complex nanostructures. In this work, a novel metal-organic ALD precursor, Tetrakis[ethylmethylamino] vanadium {V(NEtMe)₄} [TEMAV], was employed as vanadium precursor source to develop an ALD process for the synthesis of VO₂ films. For comparison of film properties, such as morphology, microstructure and electrical properties, VO₂ films were also fabricated by combining RF magnetron sputtering of Vanadium thin film and post annealing under mixture of N₂ and O₂ at low pressure.

VO₂ thin films were grown on Si using the Savannah 100 ALD system from Cambridge Nanotech. TE MAV and H₂O were employed as vanadium precursor and oxidizing agent. Generally 20 sccm N₂ was used as a carrier gas for the precursors. The growth temperature was set at 150°C. VO₂ thin film were also deposited by magnetron sputtering of a vanadium metal target (2 inch in diameter, 99.9% purity) on Si substrate. The base pressure of magnetron sputtering was less than 10⁻⁶ Torr, while sputtering deposition was conducted under Ar with a pressure of 3 mtorr. The growth temperature of Vanadium on Si substrate was controlled at 450°C to obtain high crystallinity and uniformity. However, VO₂ thin films obtained by ALD process are mostly in V₂O₅ phase. In addition, the ALD deposited thin films are amorphous since the growth temperature is lower than the crystallizing temperature. Therefore, the post thermal heat

treatment has to be used to produce polycrystalline VO₂ structure in inert gas. The as-grown thin films were annealed with N₂ plus O₂ with different ration in the furnace. Vanadium thin films deposited by magnetron sputtering were annealed under N₂ plus different amount O₂ to obtain VO₂ at temperature range from 450 to 600°C for 6 hours. From XRD and FE-SEM measurements we conclude that the amorphous phase of as-grown ALD thin films was changed into polycrystalline after 450°C annealing and magnetron sputtered vanadium thin film were oxidized in to VO₂ phase as shown in Figure 1 and 2. It is noted that vanadium oxides were considerably dependent on the O₂ concentration and oxidized atmosphere pressure for both as-grown thin films by ALD and magnetron sputtering process. In addition, Electrical and optical properties of VO₂ thin films grown by the ALD and magnetron sputtering are also discussed.

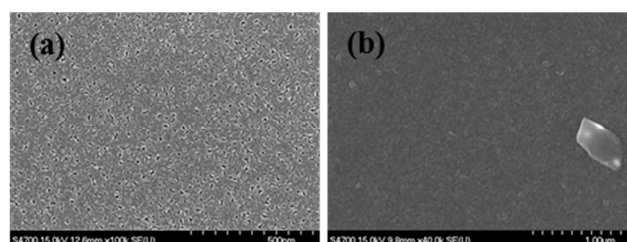


Figure 1. FE-SEM micrograph of recrystallized polycrystalline (a) thin ALD VO₂ film furnace annealed at 450 °C and (b) thin magnetron sputtering film annealed at 450°C.

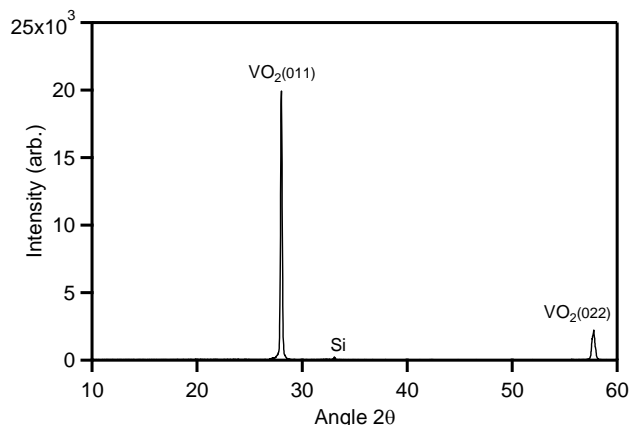


Figure 2. XRD pattern of VO₂ thin films obtained by annealing of magnetron sputtered vanadium films at 600°C under mixture of N₂ and O₂.

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